

SwitchReg™

1.5A, 1.4MHz Step-Down Converter

General Description

The AAT1112 SwitchReg is a 1.5A step-down converter with an input voltage range of 2.4V to 5.5V and an adjustable output voltage from 0.6V to $V_{\rm IN}$. The 1.4MHz switching frequency enables the use of small external components. The small footprint and high efficiency make the AAT1112 an ideal choice for portable applications.

The AAT1112 delivers 1.5A maximum output current while consuming only $42\mu A$ of no-load quiescent current. Ultra-low $R_{DS(ON)}$ integrated MOSFETs and 100% duty cycle operation make the AAT1112 an ideal choice for high output voltage, high current applications which require a low dropout threshold.

The AAT1112 provides excellent transient response and high output accuracy across the operating range. No external compensation components are required.

The AAT1112 is designed to maintain high efficiency throughout the load range. Pulling the MODE/ SYNC pin high enables "PWM Only" mode, maintaining constant frequency and low output ripple across the operating range. Alternatively, the converter may be synchronized to an external clock input via the MODE/SYNC pin. Overtemperature and short-circuit protection safeguard the AAT1112 and system components from damage.

The AAT1112 is available in a Pb-free, space-saving TDFN33-12 or 2.75x3mm TSOPJW-12 package. The product is rated over an operating temperature range of -40°C to +85°C.

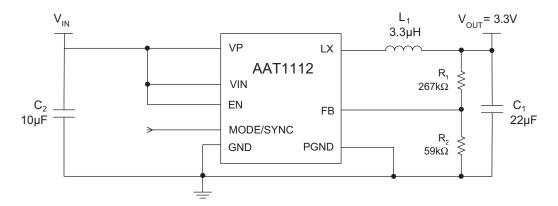
Features

- 1.5A Maximum Output Current
- Input Voltage: 2.4V to 5.5V
- Output Voltage: 0.6V to V_{IN}
- Up to 95% Efficiency
- 42µA No Load Quiescent Current
- No External Compensation Required
- 1.4MHz Switching Frequency
- Synchronizable to External Clock
- Optional "PWM Only" Low Noise Mode
- 100% Duty Cycle Low-Dropout Operation
- Internal Soft Start
- Over-Temperature and Current Limit Protection
- <1µA Shutdown Current
- TSOPJW-12 or TDFN33-12 Package
- Temperature Range: -40°C to +85°C

Applications

- Cellular Phones
- Digital Cameras
- Hard Disk Drives
- MP3 Players
- PDAs and Handheld Computers
- Portable Media Players
- USB Devices

Typical Application





SwitchReg™

I.5A, I.4MHz Step-Down Converter

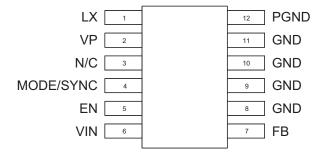
Pin Descriptions

Pin #			
TSOPJW-12	TDFN33-12	Symbol	Function
1	12	LX	Switching node. Connect the output inductor to this pin. The switching node is internally connected to the drain of both high- and low-side MOSFETs.
2	11	VP	Input voltage for the power switches.
3	10	N/C	Not connected.
4	9	MODE/SYNC	Connect to ground for PFM/PWM mode and optimized efficiency throughout the load range. Connect high for low noise PWM operation under all operating conditions. Connect to an external clock for synchronization (PWM only).
5	8	EN	Enable pin. A logic low disables the converter and it consumes less than $1\mu A$ of current. When connected high, it resumes normal operation.
6	7	VIN	Power supply. Supplies power for the internal circuitry.
7	6	FB	Feedback input pin. This pin is connected either directly to the converter output or to an external resistive divider for an adjustable output.
8, 9, 10, 11	4, 5	GND	Non-power signal ground pin.
12	1, 2, 3	PGND	Main power ground return pin. Connect to the output and input capacitor return.
N/A	EP		Exposed paddle (bottom); connect to ground as closely as possible to the device.

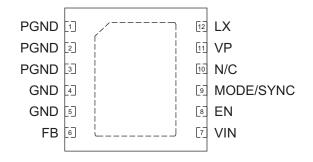
Pin Configuration

2





TDFN33-12 (Top View)







SwitchReg[™]

I.5A, I.4MHz Step-Down Converter

Absolute Maximum Ratings¹

Symbol	Description	Value	Units
V_{IN}	VIN, VP to GND	6.0	V
V_{LX}	LX Pin to GND	-0.3 to V _{IN} + 0.3	V
V_{FB}	FB Pin to GND	-0.3 to $V_{IN} + 0.3$	V
V_N	MODE/SYNC, EN to GND	-0.3 to 6.0	V
T ₁	Operating Junction Temperature Range	-40 to 150	°C
T_{LEAD}	Maximum Soldering Temperature (at leads, 10 sec)	300	°C

Thermal Information

Symbol	Description		Value	Units
P_{D}	Maximum Dower Dissipation	TSOPJW-12	0.625	W
	Maximum Power Dissipation	TDFN33-12	2.0	VV
$\theta_{ exttt{JA}}$	Thermal Resistance ²	TSOPJW-12	160	°C/W
		TDFN33-12	50	°C/ VV

^{1.} Stresses above those listed in Absolute Maximum Ratings may cause permanent damage to the device. Functional operation at conditions other than the operating conditions specified is not implied. Only one Absolute Maximum Rating should be applied at any one time.

^{2.} Mounted on an FR4 board.



SwitchReg[™]

1.5A, 1.4MHz Step-Down Converter

Electrical Characteristics¹

 $V_{IN}=3.6V;\ T_A=-40$ °C to +85 °C, unless otherwise noted. Typical values are $T_A=25$ °C.

Symbol	Description	Conditions	Min	Тур	Max	Units
V_{IN}	Input Voltage		2.4		5.5	V
V_{OUT}	Output Voltage Range		0.6		V _{IN}	V
		V _{IN} Rising			2.4	V
V_{UVLO}	UVLO Threshold	Hysteresis		250		mV
		V _{IN} Falling	1.8			V
V_{OUT}	Output Voltage Tolerance	$I_{OUT} = 0A \text{ to } 1.5A, V_{IN} = 2.4V \text{ to } 5.5V$	-3.0		3.0	%
I_Q	Quiescent Current	No Load		42	90	μΑ
I_{SHDN}	Shutdown Current	$V_{EN} = GND$			1.0	μΑ
I_{LIM}	Current Limit		1.8			Α
R _{DS(ON)H}	High Side Switch On-Resistance			0.120		Ω
R _{DS(ON)L}	Low Side Switch On-Resistance			0.085		Ω
I _{LXLEAK}	LX Leakage Current	$V_{IN} = 5.5V$, $V_{LX} = 0$ to V_{IN}			1.0	μΑ
I _{LXLK, R}	LX Reverse Leakage Current	V_{IN} Unconnected, $V_{LX} = 5.5V$, $V_{EN} = GND$			1.0	μΑ
$\Delta V_{LOADREG}$	Load Regulation	$I_{LOAD} = 0A \text{ to } 1.5A$		0.5		%
$\Delta V_{LINEREG} / \Delta V_{IN}$	Line Regulation	V _{IN} = 2.4V to 5.5V		0.2		%/V
V_{FB}	Feedback Threshold Voltage Accuracy (Adjustable Version)	No Load, T _A = 25°C	0.591	0.60	0.609	V
I_{FB}	FB Leakage Current	$V_{OUT} = 1.0V$			0.2	μΑ
	Internal Oscillator Frequency		1.12	1.4	1.68	NAL I-
Fosc	Synchronous Clock		0.60		3.0	MHz
Ts	Start-Up Time	From Enable to Output Regulation		150		μs
T _{SD}	Over-Temperature Shutdown Threshold			140		°C
T _{HYS}	Over-Temperature Shutdown Threshold			15		°C
EN						
V _{IL}	Enable Threshold Low				0.6	V
V _{IH}	Enable Threshold High		1.4			V
I _{EN}	Enable Leakage Current	$V_{IN} = V_{EN} = 5.5V$	-1.0		1.0	μA
MODE/SYN	IC					·
V _{MODE/SYNC(L)}	Enable Threshold Low				0.6	V
V _{MODE/SYNC(H)}	Enable Threshold High		1.4			V
I _{MODE/SYNC}	Enable Leakage Current	$V_{IN} = V_{FN} = 5.5V$	-1.0		1.0	μΑ

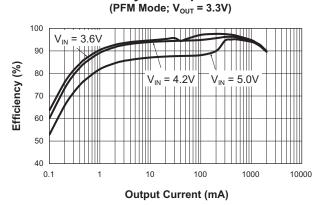
^{1.} The AAT1112 is guaranteed to meet performance specifications over the -40°C to +85°C operating temperature range and is assured by design, characterization, and correlation with statistical process controls.



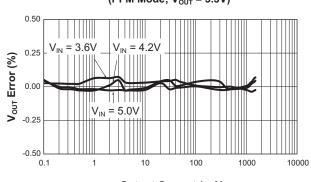
1.5A, 1.4MHz Step-Down Converter

Typical Characteristics

Efficiency vs. Output Current

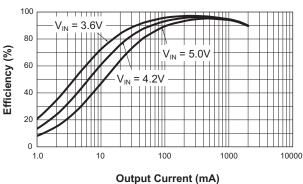


Load Regulation (PFM Mode; $V_{OUT} = 3.3V$)

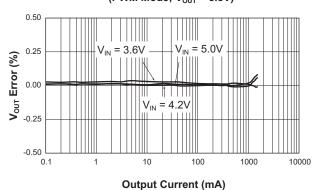


Output Current (mA)

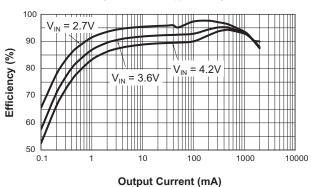
Efficiency vs. Output Current (PWM Mode; V_{OUT} = 3.3V)



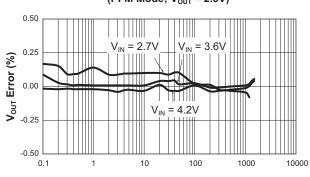
Load Regulation (PWM Mode; $V_{OUT} = 3.3V$)



Efficiency vs. Output Current (PFM Mode; $V_{OUT} = 2.5V$)



Load Regulation (PFM Mode; $V_{OUT} = 2.5V$)



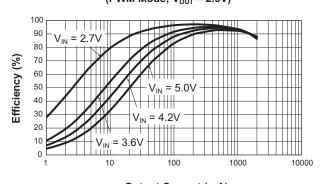
Output Current (mA)



1.5A, 1.4MHz Step-Down Converter

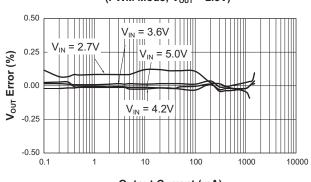
Typical Characteristics

Efficiency vs. Output Current (PWM Mode; V_{OUT} = 2.5V)



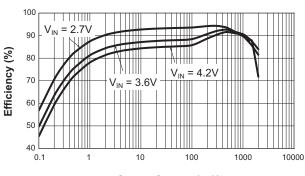
Output Current (mA)

Load Regulation (PWM Mode; V_{OUT} = 2.5V)



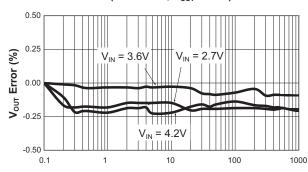
Output Current (mA)

Efficiency vs. Output Current (PFM Mode; V_{OUT} = 1.8V)



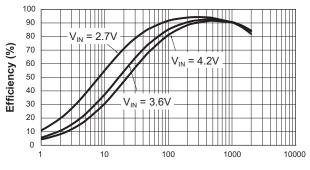
Output Current (mA)

Load Regulation (PFM Mode; V_{OUT} = 1.8V)



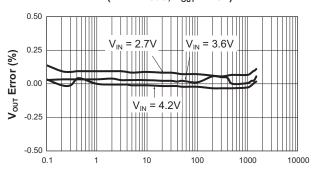
Output Current (mA)

Efficiency vs. Output Current (PWM Mode; V_{OUT} = 1.8V)



Output Current (mA)

Load Regulation (PWM Mode; V_{out} = 1.8V)



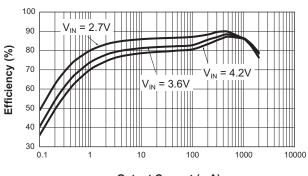
Output Current (mA)



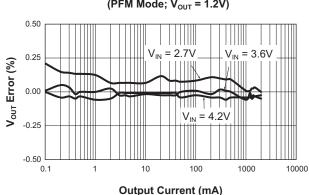
1.5A, 1.4MHz Step-Down Converter

Typical Characteristics

Efficiency vs. Output Current (PFM Mode; V_{OUT} = 1.2V)

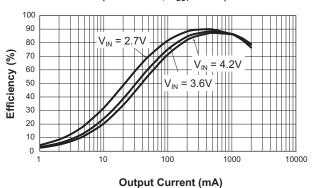


Load Regulation (PFM Mode; $V_{OUT} = 1.2V$)

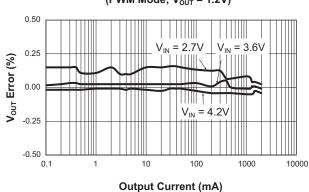


Output Current (mA)

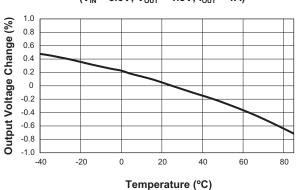
Efficiency vs. Output Current (PWM Mode; V_{OUT} = 1.2V)



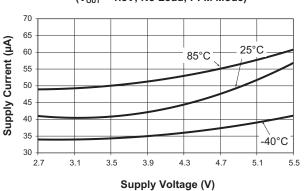
Load Regulation (PWM Mode; V_{OUT} = 1.2V)



Output Voltage vs. Temperature $(V_{IN} = 3.6V; V_{OUT} = 1.8V; I_{OUT} = 1A)$



Supply Current vs. Supply Voltage (V_{OUT} = 1.8V; No Load; PFM Mode)

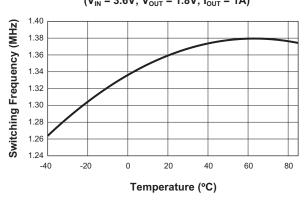




1.5A, 1.4MHz Step-Down Converter

Typical Characteristics

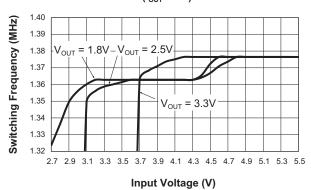
Switching Frequency vs. Temperature (V_{IN} = 3.6V; V_{OUT} = 1.8V; I_{OUT} = 1A)



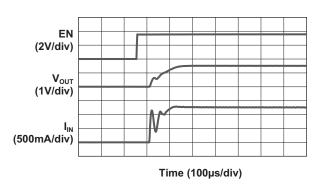
-0.04

2.7 2.9 3.1 3.3 3.5 3.7 3.9 4.1 4.3 4.5 4.7 4.9 5.1 5.3 5.5 Supply Voltage (V)

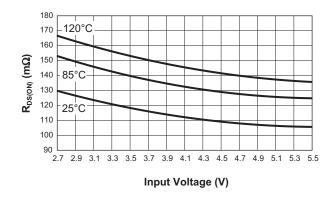
Switching Frequency vs. Input Voltage (I_{OUT} = 1A)



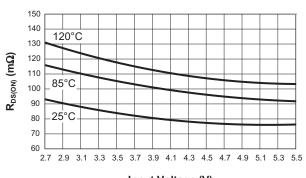




P-Channel R_{DS(ON)} vs. Input Voltage



N-Channel R_{DS(ON)} vs. Input Voltage



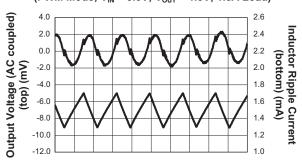
Input Voltage (V)



1.5A, 1.4MHz Step-Down Converter

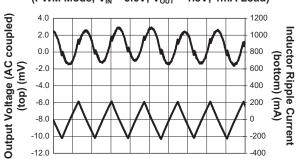
Typical Characteristics

Heavy Load Switching Waveform (PWM Mode; V_{IN} = 3.6V; V_{OUT} = 1.8V; 1.5A Load)



Time (2.5µs/div)

Light Load Switching Waveform (PWM Mode; V_{IN} = 3.6V; V_{OUT} = 1.8V; 1mA Load)



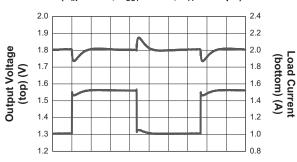
Time (2.5µs/div)

Light Load Switching Waveform (PFM Mode; V_{IN} = 3.6V; V_{OUT} = 1.8V; 1mA Load)



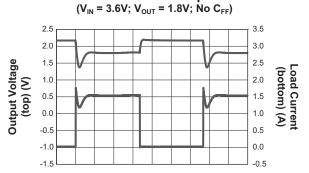
Time (100µs/div)

Load Transient Response (V_{IN} = 3.6V; V_{OUT} = 1.8V; C_{FF} = 100pF)



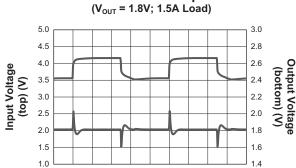
Time (20µs/div)

Load Transient Response



Time (50µs/div)

Line Transient Response

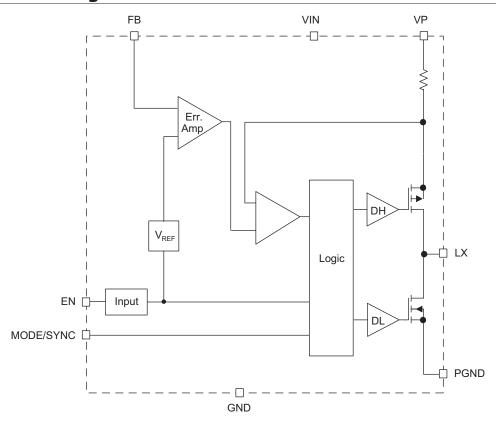


Time (200µs/div)



1.5A, 1.4MHz Step-Down Converter

Functional Block Diagram



Functional Description

The AAT1112 is a high performance 1.5A monolithic step-down converter operating at 1.4MHz switching frequency. It minimizes external component size and optimizes efficiency over the complete load range. Apart from the small bypass input capacitor, only a small L-C filter is required at the output. Typically, a $3.3\mu H$ inductor and a $22\mu F$ ceramic capacitor are recommended for a 3.3V output (see table of recommended values).

At dropout, the converter duty cycle increases to 100% and the output voltage tracks the input voltage minus the $R_{\text{DS(ON)}}$ drop of the P-channel high-side MOSFET (plus the DC drop of the external inductor). The device integrates extremely low $R_{\text{DS(ON)}}$ MOSFETs to achieve low dropout voltage during 100% duty cycle operation. This is advantageous in applications requiring high output voltages (typically > 2.5 V) at low input voltages.

The integrated low-loss MOSFET switches can provide greater than 95% efficiency at full load. PFM operation

maintains high efficiency under light load conditions (typically <150mA). The MODE/ SYNC pin allows optional "PWM only" mode. This maintains constant frequency and low output ripple across all load conditions. Alternatively, the IC can be synchronized to an external clock via the MODE/ SYNC input. External synchronization is maintained between 0.6MHz and 3.0MHz.

In battery-powered applications, as $V_{\rm IN}$ decreases, the converter dynamically adjusts the operating frequency prior to dropout to maintain the required duty cycle and provide accurate output regulation. Output regulation is maintained until the dropout voltage, or minimum input voltage, is reached. At 1.5A output load, dropout voltage headroom is approximately 200mV.

The AAT1112 typically achieves better than $\pm 0.5\%$ output regulation across the input voltage and output load range. A current limit of 2.0A (typical) protects the IC and system components from short-circuit damage. Typical no load quiescent current is $42\mu A$.





1.5A, 1.4MHz Step-Down Converter

Thermal protection completely disables switching when the maximum junction temperature is detected. The junction over-temperature threshold is 140°C with 15°C of hysteresis. Once an over-temperature or over-current fault condition is removed, the output voltage automatically recovers.

Peak current mode control and optimized internal compensation provide high loop bandwidth and excellent response to input voltage and fast load transient events. Soft start eliminates output voltage overshoot when the enable or the input voltage is applied. Under-voltage lockout prevents spurious start-up events.

Control Loop

The AAT1112 is a peak current mode step-down converter. The current through the P-channel MOSFET (high side) is sensed for current loop control, as well as short-circuit and overload protection. A fixed slope compensation signal is added to the sensed current to maintain stability for duty cycles greater than 50%. The peak current mode loop appears as a voltage-programmed current source in parallel with the output capacitor.

The output of the voltage error amplifier programs the current mode loop for the necessary peak switch current to force a constant output voltage for all load and line conditions. Internal loop compensation terminates the transconductance voltage error amplifier output. The reference voltage is internally set to program the converter output voltage greater than or equal to 0.6V.

Soft Start/Enable

Soft start limits the current surge seen at the input and eliminates output voltage overshoot. When pulled low, the enable input forces the AAT1112 into a low-power, non-switching state. The total input current during shutdown is less than $1\mu A$.

Current Limit and Over-Temperature Protection

For overload conditions, the peak input current is limited. To minimize power dissipation and stresses under current limit and short-circuit conditions, switching is terminated after entering current limit for a series of pulses. Switching is terminated for seven consecutive clock cycles after a current limit has been sensed for a series of four consecutive clock cycles.

Thermal protection completely disables switching when internal dissipation becomes excessive. The junction over-temperature threshold is 140°C with 15°C of hysteresis. Once an over-temperature or over-current fault conditions is removed, the output voltage automatically recovers.

Under-Voltage Lockout

Internal bias of all circuits is controlled via the VIN input. Under-voltage lockout (UVLO) guarantees sufficient $V_{\rm IN}$ bias and proper operation of all internal circuitry prior to activation.

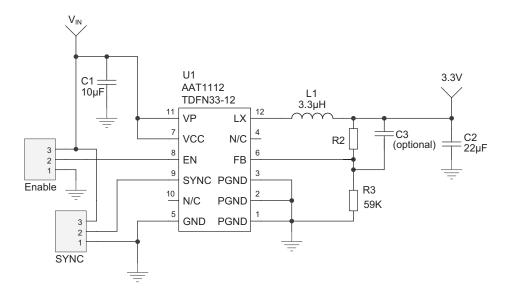


Figure 1: AAT1112 Schematic.



Component Selection

Inductor Selection

The step-down converter uses peak current mode control with slope compensation to maintain stability for duty cycles greater than 50%. The output inductor value must be selected so the inductor current down slope meets the internal slope compensation requirements. The inductor should be set equal to the output voltage numeric value in μH . This guarantees that there is sufficient internal slope compensation.

Manufacturer's specifications list both the inductor DC current rating, which is a thermal limitation, and the peak current rating, which is determined by the saturation characteristics. The inductor should not show any appreciable saturation under normal load conditions. Some inductors may meet the peak and average current ratings yet result in excessive losses due to a high DCR. Always consider the losses associated with the DCR and its effect on the total converter efficiency when selecting an inductor.

The $3.3\mu H$ CDRH4D28 series Sumida inductor has a $49.2m\Omega$ worst case DCR and a 1.57A DC current rating. At full 1.5A load, the inductor DC loss is 97mW which gives less than 1.5% loss in efficiency for a 1.5A, 3.3V output.

Input Capacitor

Select a $10\mu F$ to $22\mu F$ X7R or X5R ceramic capacitor for the input. To estimate the required input capacitor size, determine the acceptable input ripple level (V_{PP}) and solve for C. The calculated value varies with input voltage and is a maximum when V_{IN} is double the output voltage.

$$\begin{split} C_{\text{IN}} &= \frac{\frac{V_{\text{O}}}{V_{\text{IN}}} \cdot \left(1 - \frac{V_{\text{O}}}{V_{\text{IN}}}\right)}{\left(\frac{V_{\text{PP}}}{I_{\text{O}}} - \text{ESR}\right) \cdot F_{\text{S}}} \\ &\frac{V_{\text{O}}}{V_{\text{IN}}} \cdot \left(1 - \frac{V_{\text{O}}}{V_{\text{IN}}}\right) = \frac{1}{4} \text{ for } V_{\text{IN}} = 2 \cdot V_{\text{O}} \\ C_{\text{IN(MIN)}} &= \frac{1}{\left(\frac{V_{\text{PP}}}{I_{\text{O}}} - \text{ESR}\right) \cdot 4 \cdot F_{\text{S}}} \end{split}$$

1.5A, 1.4MHz Step-Down Converter

Always examine the ceramic capacitor DC voltage coefficient characteristics when selecting the proper value. For example, the capacitance of a $10\mu F$, 6.3V, X5R ceramic capacitor with 5.0V DC applied is actually about $6\mu F$.

The maximum input capacitor RMS current is:

$$I_{RMS} = I_{O} \cdot \sqrt{\frac{V_{O}}{V_{IN}} \cdot \left(1 - \frac{V_{O}}{V_{IN}}\right)}$$

The input capacitor RMS ripple current varies with the input and output voltage and will always be less than or equal to half of the total DC load current.

$$\sqrt{\frac{V_O}{V_{IN}} \cdot \left(1 - \frac{V_O}{V_{IN}}\right)} = \sqrt{D \cdot (1 - D)} = \sqrt{0.5^2} = \frac{1}{2}$$

for V_{IN} = 2 \cdot V_{O}

$$I_{RMS(MAX)} = \frac{I_0}{2}$$

The term $\frac{V_o}{V_{IN}} \cdot \left(1 - \frac{V_o}{V_{IN}}\right)$ appears in both the input voltage ripple and input capacitor RMS current equations and is a maximum when V_o is twice V_{IN} . This is why the input voltage ripple and the input capacitor RMS current ripple are a maximum at 50% duty cycle.

The input capacitor provides a low impedance loop for the edges of pulsed current drawn by the AAT1112. Low ESR/ESL X7R and X5R ceramic capacitors are ideal for this function. To minimize stray inductance, the capacitor should be placed as closely as possible to the IC. This keeps the high frequency content of the input current localized, minimizing EMI and input voltage ripple.

The proper placement of the input capacitor (C1) can be seen in the evaluation board layout in the Layout section of this datasheet (see Figure 2).

A laboratory test set-up typically consists of two long wires running from the bench power supply to the evaluation board input voltage pins. The inductance of these wires, along with the low-ESR ceramic input capacitor, can create a high Q network that may affect converter performance. This problem often becomes apparent in the form of excessive ringing in the output voltage during load transients. Errors in the loop phase and gain measurements can also result.





1.5A, 1.4MHz Step-Down Converter

Since the inductance of a short PCB trace feeding the input voltage is significantly lower than the power leads from the bench power supply, most applications do not exhibit this problem.

In applications where the input power source lead inductance cannot be reduced to a level that does not affect the converter performance, a high ESR tantalum or aluminum electrolytic should be placed in parallel with the low ESR/ESL bypass ceramic capacitor. This dampens the high O network and stabilizes the system.

Output Capacitor

The output capacitor limits the output ripple and provides holdup during large load transitions. A 10 μ F to 22 μ F X5R or X7R ceramic capacitor typically provides sufficient bulk capacitance to stabilize the output during large load transitions and has the ESR and ESL characteristics necessary for low output ripple.

The output voltage droop due to a load transient is dominated by the capacitance of the ceramic output capacitor. During a step increase in load current, the ceramic output capacitor alone supplies the load current until the loop responds. Within two or three switching cycles, the loop responds and the inductor current increases to match the load current demand. The relationship of the output voltage droop during the three switching cycles to the output capacitance can be estimated by:

$$C_{OUT} = \frac{3 \cdot \Delta I_{LOAD}}{V_{DROOP} \cdot F_{S}}$$

Once the average inductor current increases to the DC load level, the output voltage recovers. The above equation establishes a limit on the minimum value for the output capacitor with respect to load transients.

The internal voltage loop compensation also limits the minimum output capacitor value to $10\mu F$. This is due to its effect on the loop crossover frequency (bandwidth), phase margin, and gain margin. Increased output capacitance will reduce the crossover frequency with greater phase margin.

Adjustable Output Resistor Selection

The output voltage on the AAT1112 is programmed with external resistors R1 and R2. To limit the bias current required for the external feedback resistor string while

maintaining good noise immunity, the minimum suggested value for R2 is $59k\Omega.$ Although a larger value will further reduce quiescent current, it will also increase the impedance of the feedback node, making it more sensitive to external noise and interference. Table 1 summarizes the resistor values for various output voltages with R2 set to either $59k\Omega$ for good noise immunity or $221k\Omega$ for reduced no load input current.

V _{out} (V)	$R2 = 59k\Omega$ $R1 (k\Omega)$	R2 = 221kΩ R1 (kΩ)
0.8	19.6	75
0.9	29.4	113
1.0	39.2	150
1.1	49.9	187
1.2	59.0	221
1.3	68.1	261
1.4	78.7	301
1.5	88.7	332
1.8	118	442
1.85	124	464
2.0	137	523
2.5	187	715
3.0	237	887
3.3	267	1000

Table 1: AAT1112 Resistor Values for Various Output Voltages.

Thermal Calculations

There are three types of losses associated with the AAT1112 step-down converter: switching losses, conduction losses, and quiescent current losses. Conduction losses are associated with the $R_{\text{DS(ON)}}$ characteristics of the power output switching devices. Switching losses are dominated by the gate charge of the power output switching devices. At full load, assuming continuous conduction mode (CCM), a simplified form of the losses is given by:

$$P_{TOTAL} = \frac{I_O^2 \cdot (R_{DS(ON)H} \cdot V_O + R_{DS(ON)L} \cdot [V_{IN} - V_O])}{V_{IN}}$$

+
$$(t_{sw} \cdot F_S \cdot I_O + I_Q) \cdot V_{IN}$$

 I_{Q} is the step-down converter quiescent current. The term t_{sw} is used to estimate the full load step-down converter switching losses.



1.5A, 1.4MHz Step-Down Converter

For the condition where the step-down converter is in dropout at 100% duty cycle, the total device dissipation reduces to:

$$P_{TOTAL} = I_0^2 \cdot R_{DS(ON)H} + I_Q \cdot V_{IN}$$

Since $R_{DS(ON)}$, quiescent current, and switching losses all vary with input voltage, the total losses should be investigated over the complete input voltage range.

Given the total losses, the maximum junction temperature can be derived from the θ_{JA} for the TDFN3-12 and TSOPJW-12 packages, which is 50°C/W and 160°C/W respectively.

$$T_{\text{J(MAX)}} = P_{\text{TOTAL}} \cdot \Theta_{\text{JA}} + T_{\text{AMB}}$$

Layout

The suggested PCB layout for the AAT1112 is shown in Figures 2 and 3. The following guidelines should be used to help ensure a proper layout.

- 1. The input capacitor (C1) should connect as closely as possible to VP and PGND.
- 2. C2 and L1 should be connected as closely as possible. The connection of L1 to the LX pin should be as short as possible.
- 3. The feedback trace or FB pin should be separate from any power trace and connect as closely as possible to the load point. Sensing along a high-current load trace will degrade DC load regulation.
- 4. The resistance of the trace from the load return to PGND should be kept to a minimum. This will help to minimize any error in DC regulation due to differences in the potential of the internal signal ground and the power ground.
- 5. Connect unused signal pins to ground to avoid unwanted noise coupling.

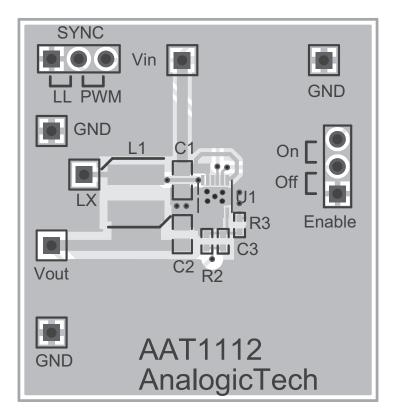


Figure 2: AAT1112 Evaluation Board Top Side Layout.

1.5A, 1.4MHz Step-Down Converter

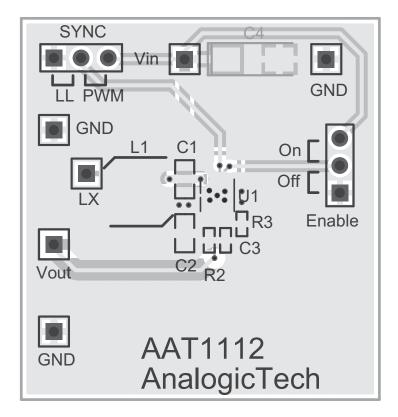


Figure 3: AAT1112 Evaluation Board Bottom Side Layout.

SwitchReg™

1.5A, 1.4MHz Step-Down Converter

Design Example

Specifications

 V_{O} 3.3V @ 1.5A, Pulsed Load ΔI_{LOAD} = 1.5A

 V_{IN} 2.7V to 4.2V (3.6V nominal)

F_S 1.2MHz

T_{AMB} 85°C in TDFN33-12 Package

Output Inductor

L1 = $V_0(\mu H)$ = 3.3 μH ; see Table 2.

For Sumida inductor CDRH4D28 3.3 μ H DCR = 49.2 $m\Omega$ max.

$$\Delta I_1 = \frac{V_0}{L1 \cdot F_S} \cdot \left(1 - \frac{V_{01}}{V_{IN}}\right) = \frac{3.3V}{3.3\mu H \cdot 1.2MHz} \cdot \left(1 - \frac{3.3V}{4.2V}\right) = 179 mA$$

$$I_{PK1} = I_{O1} + \frac{\Delta I_1}{2} = 1.5A + 0.089A = 1.59A$$

$$P_{L1} = I_{O1}^{2} \cdot DCR = 1.5A^{2} \cdot 49.2m\Omega = 110mW$$

Output Capacitor

$$V_{DROOP} = 0.2V$$

$$C_{OUT} = \frac{3 \cdot \Delta I_{LOAD}}{V_{DROOP} \cdot F_S} = \frac{3 \cdot 1.5A}{0.2V \cdot 1.2MHz} = 18.8 \mu F; use 22 \mu F$$

$$I_{\text{RMS(MAX)}} = \frac{1}{2 \cdot \sqrt{3}} \cdot \frac{(V_{\text{OUT}}) \cdot (V_{\text{IN(MAX)}} - V_{\text{OUT}})}{L \cdot F_{\text{S}} \cdot V_{\text{IN(MAX)}}} = \frac{1}{2 \cdot \sqrt{3}} \cdot \frac{3.3 \text{V} \cdot (4.2 \text{V} - 3.3 \text{V})}{3.3 \mu \text{H} \cdot 1.2 \text{MHz} \cdot 4.2 \text{V}} = 52 \text{mArms}$$

$$P_{esr} = esr \cdot I_{RMS}^2 = 5m\Omega \cdot (52mA)^2 = 13.3 \mu W$$

Input Capacitor

Input Ripple $V_{PP} = 50 \text{mV}$

$$C_{\text{IN}} = \frac{1}{\left(\frac{V_{\text{PP}}}{I_{\text{O1}} + I_{\text{O2}}} - \text{ESR}\right) \cdot 4 \cdot F_{\text{S}}} = \frac{1}{\left(\frac{50 \text{mV}}{1.5 \text{A}} - 5 \text{m}\Omega\right) \cdot 4 \cdot 1.2 \text{MHz}} = 7.3 \mu \text{F; use } 10 \mu \text{F}$$

$$I_{RMS(MAX)} = \frac{I_O}{2} = 0.75 Arms$$

$$P = esr \cdot I_{RMS}^{2} = 5m\Omega \cdot (0.75A)^{2} = 3mW$$

SwitchReg™

1.5A, 1.4MHz Step-Down Converter

AAT1112 Losses

Total losses can be estimated by calculating the dropout ($V_{IN} = V_0$) losses where the power MOSFET $R_{DS(ON)}$ will be at the maximum value. All values assume an 85°C ambient temperature and a 120°C junction temperature with the TDFN 50°C/W package.

$$P_{LOSS} = I_{O1}^{2} \cdot R_{DS(ON)H} = 1.5A^{2} \cdot 0.16\Omega = 0.36W$$

$$T_{J(MAX)} = T_{AMB} + \Theta_{JA} \cdot P_{LOSS} = 85^{\circ}C + (50^{\circ}C/W) \cdot 360 \text{mW} = 103^{\circ}C$$

The total losses are also investigated at the nominal lithium-ion battery voltage (3.6V). The simplified version of the $R_{DS(ON)}$ losses assumes that the N-channel and P-channel $R_{DS(ON)}$ are equal.

$$\begin{split} P_{\text{TOTAL}} &= I_{\text{O}}^2 \cdot R_{\text{DS(ON)}} + (t_{\text{sw}} \cdot F_{\text{S}} \cdot I_{\text{O}} + I_{\text{Q}}) \cdot V_{\text{IN}} \\ &= 1.5 \text{A}^2 \cdot 152 \text{m}\Omega + (5 \text{ns} \cdot 1.2 \text{MHz} \cdot 1.5 \text{A} + 50 \mu \text{A}) \cdot 3.6 \text{V} = 375 \text{mW} \end{split}$$

$$T_{J(MAX)} = T_{AMB} + \Theta_{JA} \cdot P_{LOSS} = 85^{\circ}C + (50^{\circ}C/W) \cdot 375mW = 104^{\circ}C$$

V _{оит} (V)	Inductance (µH)	Part Number	Manufacturer	Size (mm)	Rated Current (A)	I _{RMS} (A)	I _{SAT} (A)	DCR (Ω)
3.3	3.3	CDRH4D28	Sumida	5x5x3	1.57			36.4
2.5	2.2	CDRH4D28	Sumida	5x5x3	2.04			23.2
1.8	1.8	CDRH4D28	Sumida	5x5x3	2.2			20.4
1.5	1.8	CDRH4D28	Sumida	5x5x3	2.2			20.4
1.2	1.2	CDRH4D28	Sumida	5x5x3	2.56			17.5
1.0	1.0	SD3114-1.0	Cooper	3.1x3.1x1.45		1.67	2.07	0.042
0.8	1.0	SD3114-1.0	Cooper	3.1x3.1x1.45		1.67	2.07	0.042
0.6	1.0	SD3114-1.0	Cooper	3.1x3.1x1.45		1.67	2.07	0.042

Table 2: Surface Mount Inductors.

Manufacturer	Part Number	Value	Voltage	Temp. Co.	Case
Murata	GRM21BR60J106KE19	10μF	6.3V	X5R	0805
Murata	GRM21BR60J226ME39	22µF	6.3V	X5R	0805

Table 3: Surface Mount Capacitors.



SwitchReg[™]

I.5A, I.4MHz Step-Down Converter

Ordering Information

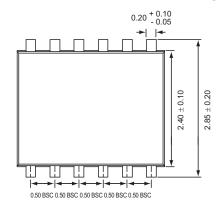
Package	Marking ¹	Part Number (Tape and Reel) ²
TSOPJW-12	YVXYY	AAT1112ITP-0.6-T13
TDFN33-12	SBXYY	AAT1112IWP-0.6-T1 ³

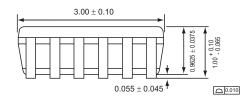


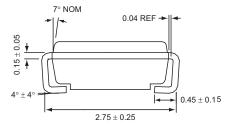
All AnalogicTech products are offered in Pb-free packaging. The term "Pb-free" means semiconductor products that are in compliance with current RoHS standards, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. For more information, please visit our website at http://www.analogictech.com/aboutus/quality.php.

Package Information⁴

TSOPJW-12







All dimensions in millimeters.

^{1.} XYY = assembly and date code.

^{2.} Sample stock is generally held on part numbers listed in **BOLD**.

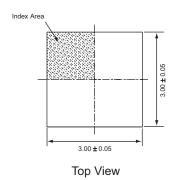
^{3.} Available exclusively outside of the United States and its territories.

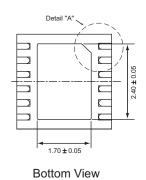
^{4.} The leadless package family, which includes QFN, TQFN, DFN, TDFN and STDFN, has exposed copper (unplated) at the end of the lead terminals due to the manufacturing process. A solder fillet at the exposed copper edge cannot be guaranteed and is not required to ensure a proper bottom solder connection.

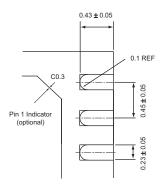


1.5A, 1.4MHz Step-Down Converter

TDFN33-12







Detail "A"



Side View

All dimensions in millimeters.

Advanced Analogic Technologies, Inc.

3230 Scott Boulevard, Santa Clara, CA 95054 Phone (408) 737-4600 Fax (408) 737-4611



© Advanced Analogic Technologies, Inc.

(a) Advanced Analogic lectnologies, Inc.
AnalogicTech cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in an AnalogicTech product. No circuit patent licenses, copyrights, mask work rights, or other intellectual property rights are implied. AnalogicTech reserves the right to make changes to their products or specifications or to discontinue any product or service without notice. Except as provided in AnalogicTech's terms and conditions of sale, AnalogicTech assumes no liability whatsoever, and AnalogicTech disclaims any express or implied warranty relating to the sale and/or use of AnalogicTech products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right. In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards. Testing and other quality control techniques are utilized to the extent AnalogicTech deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed. AnalogicTech logo are trademarks of Advanced Analogic Technologies Incorporated. All other brand and product names appearing in this document are registered trademarks or trademarks of their respective holders.